



Docket No.: M4065.0374/P374  
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Mike Brooks

**RECEIVED**

Application No.: 09/760,741

Art Unit: 2815

FEB 27 2004

Filed: January 17, 2001

Examiner: C. C. Chu

For: SEMICONDUCTOR ASSEMBLY  
WITHOUT ADHESIVE FILLETS

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated December 30, 2003, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Amendments to the Drawings** begin on page 9 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

**Amendments to the Specification** begin on page 10 of this paper

**Remarks** begin on page 11 of this paper.

An **Appendix** including amended drawing figures is attached following page 23 of this paper.